Surface Mount Schottky Barrier Rectifier Reverse Voltage - 200 V Forward Current - 3.0A

FEATURES

- · Metal silicon junction, majority carrier conduction
- For surface mounted applications
- · Low power loss, high efficiency
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

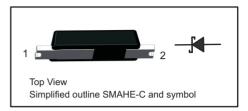
• Case: SMAHE-C

• Terminals: Solderable per MIL-STD-750, Method 2026

· Approx. Weight: 30mg / 0.0010oz

PINNING

PIN	DESCRIPTION	
1	Cathode	
2	Anode	



Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS320AHEMN	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	٧
Maximum RMS voltage	V _{RMS}	140	V
Maximum DC Blocking Voltage	V _{DC}	200	V
Maximum Average Forward Rectified Current @ Fig.1	I _{F(AV)}	3.0	Α
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	100	А
Peak Forward Surge Current,1.0ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	200	А
I²t Rating for fusing(3ms≤t≤8.3ms)	l ² t	41.5	A ² S
Max Instantaneous Forward Voltage at 3 A	V _F	0.95	V
Maximum DC Reverse Current $T_a = 25^{\circ}$ C at Rated DC Reverse Voltage $T_a = 100^{\circ}$ C	I _R	1.0 50	mA
Typical Junction Capacitance (1)	Cj	60	pF
Typical Thermal Resistance (2)	R _{0JA} R _{0JC} R _{0JL}	95 20 25	°C/W
Operating Junction Temperature Range	Tj	-55 ~ +150	°C
Storage Temperature Range	T _{stg}	-55 ~ +150	°C

⁽¹⁾ Measured at 1 MHz and applied reverse voltage of 4 V D.C

⁽²⁾ P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

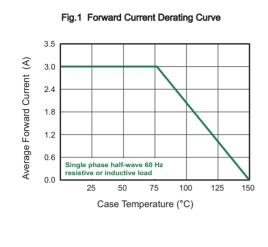


Fig.3 Typical Forward Characteristic

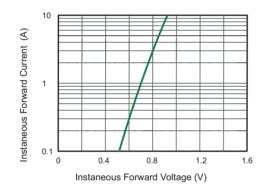


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

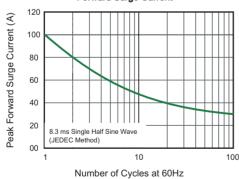


Fig.2 Typical Reverse Characteristics

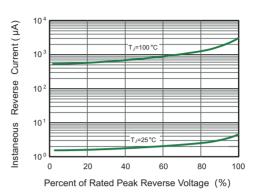
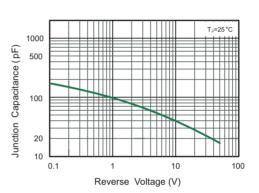


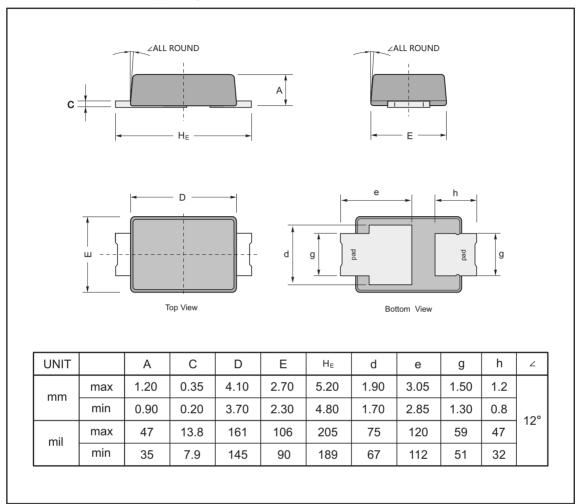
Fig.4 Typical Junction Capacitance



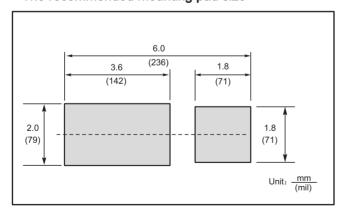
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAHE-C



The recommended mounting pad size



Marking

Type number	Marking code
SS320AHEMN	\$320N

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